ASSOCIATION CONNECTING ELECTROMICS INDUSTRIES International and Pan-American c	burn, Illinois, All rights reserved	under both This do	ocument is a declara arts, the declaration	tion of the substandencompasses all lo	ces within the manufactur ower level materials for w	rer listed item. Note: hich the manufacture	if the item is an a er has engineering	ssembly with lowe responsibility.	
752-21.1 IPC Web Site for Information on http://www.ipc.org/IPC-175x	IPC-1752 Standard	Form Type * Distribute		claration Class * ass 6 - RoHS Yes/I	No, Homogeneous Materi	als and Mfg Informa	ls and Mfg Information		
Supplier Information									
Company name*	Company unique ID		Unique ID Authority			Response Date*			
onsemi						2023-06-08			
Contact Name	Title - Contact		Phone - Conta	Phone - Contact*			Email - Contact*		
Product-Env-Stewards	Product Enviro Compliance		NA	NA			Product-Env-Stewards@onsemi.com		
Authorized Representative*	I Representative* Title - Representative		Phone - Representative*			Email - Representative*			
Product-Env-Stewards	Product Enviro Compliance	ro Compliance		NA			Product-Env-Stewards@onsemi.com		
Requester Item Number Mfr Item	n Number Mfr Item Name		Effective Dat	e Version	Manufacturing Site	Weight*	UOM	Unit Type	
NCV850	50MN300R2G 3.0V, LDO WIT	HENABLE	2023-06-08		MY1	20.0	mg	Each	
Manufacturing Proccess Information	·					·			
Terminal Plating / Grid Array Material	Ferminal Base Alloy	J-STD-020 MSL Rating	g Peak Pro	cess Body Temper	ature Max Time at Peak	Temperature Num	ber of Reflow Cy	cles	
Matte Tin (Sn) - annealed	Matte Tin (Sn) - annealed CU Alloy		260	С	30	seconds 3			
omments									
evel 1 - maximum time at peak temperature during so	Idering is 10-30 seconds								
or more information regarding material composition	please refer to page 3								

RoHS Material Composition Declaration				Declaration Type *	Detailed			
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).							
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of			
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted			
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all			
Exemption List Version	EL-2011/534/EU							
Declaration Signature								
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the			
Supplier Digital Signature Ra	stislav Drska	Le						

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.2	mg	Supplier	Silicon (Si)	7440-21-3		0.2	mg
Die Attach (	0.45	mg	Supplier	Silver (Ag)	7440-22-4		0.3375	mg
			Supplier	Epoxy resins	129915-35-1		0.1125	mg
Lead Frame 6.9	6.97	mg	Supplier	Silver (Ag)	7440-22-4		1.9446	mg
			Supplier	Iron (Fe)	7439-89-6		0.0767	mg
			Supplier	Copper (Cu)	7440-50-8		4.9487	mg
Mold Compound-Black	10.0	mg	Supplier	Epoxy and Phenolic Resin	40216-08-8		0.8	mg
			Supplier	Carbon Black (C)	1333-86-4		0.05	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.2	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8.65	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.3	mg
Plating	0.71	mg	Supplier	Tin (Sn)	7440-31-5		0.71	mg
Wire Bond - Au	1.67	mg	Supplier	Gold (Au)	7440-57-5		1.67	mg